

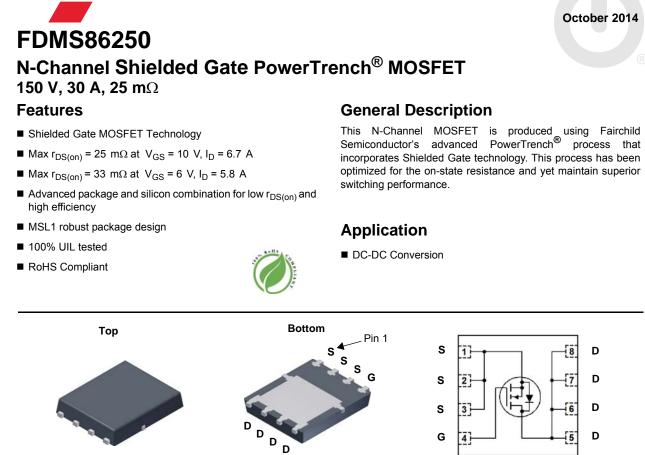
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Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		30		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	6.7	Α	
	-Pulsed		(Note 4)	100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	180	mJ	
D	Power Dissipation	T _C = 25 °C		96	w	
PD	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

Thermal Characteristics

FAIRCHILD

ł	$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.3	°C/W	
ł	$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	0/10	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86250	FDMS86250	Power 56	13 "	12 mm	3000 units

FDMS86250 N-Channel Shielded Gate PowerTrench $^{\textcircled{R}}$ MOSFET

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.0	2.9	4.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		-	11		m)//°C
ΔT_{J}	Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-11		mV/°C
r _{DS(on)}		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}$		19	25	
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 5.8 A$		23	33	mΩ
-		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		35	46	0
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 6.7 A		24		S
-	Characteristics					
C _{iss}	Input Capacitance			1750	2330	pF
C _{oss}	Output Capacitance	── V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		165	220	pF
C _{rss}	Reverse Transfer Capacitance			8.8	15	pF
R _g	Gate Resistance			0.5		Ω
	a Characteristics					
Switchin	u Characterístics					
	g Characteristics			14	25	ns
t _{d(on)}	Turn-On Delay Time Rise Time	Voo = 75 V lo = 6 7 A			25 10	ns ns
t _{d(on)} t _r	Turn-On Delay Time Rise Time	V_{DD} = 75 V, I _D = 6.7 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		14 4.3 22	-	_
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time	V _{DD} = 75 V, I _D = 6.7 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		4.3	10	ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		4.3 22 4.2	10 35	ns ns ns
t _{d(on)} t <u>r</u> t _{d(off)} t _f Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	V_{GS} = 10 V, R _{GEN} = 6 Ω V _{GS} = 0 V to 10 V		4.3 22	10 35 10	ns ns
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω		4.3 22 4.2 25	10 35 10 36	ns ns ns nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V_{GS} = 0 V to 10 V V_{GS} = 0 V to 5 V V_{DD} = 75 V,		4.3 22 4.2 25 14	10 35 10 36	ns ns nS nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V_{GS} = 0 V to 10 V V_{GS} = 0 V to 5 V V_{DD} = 75 V,		4.3 22 4.2 25 14 7.4	10 35 10 36	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 75 \text{ V},$ $I_D = 6.7 \text{ A}$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 75 \text{ V},$ $I_D = 6.7 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A} (\text{Note } 2)$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20 1.2	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-So	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 75 \text{ V},$ $I_D = 6.7 \text{ A}$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20	ns ns nC nC nC nC



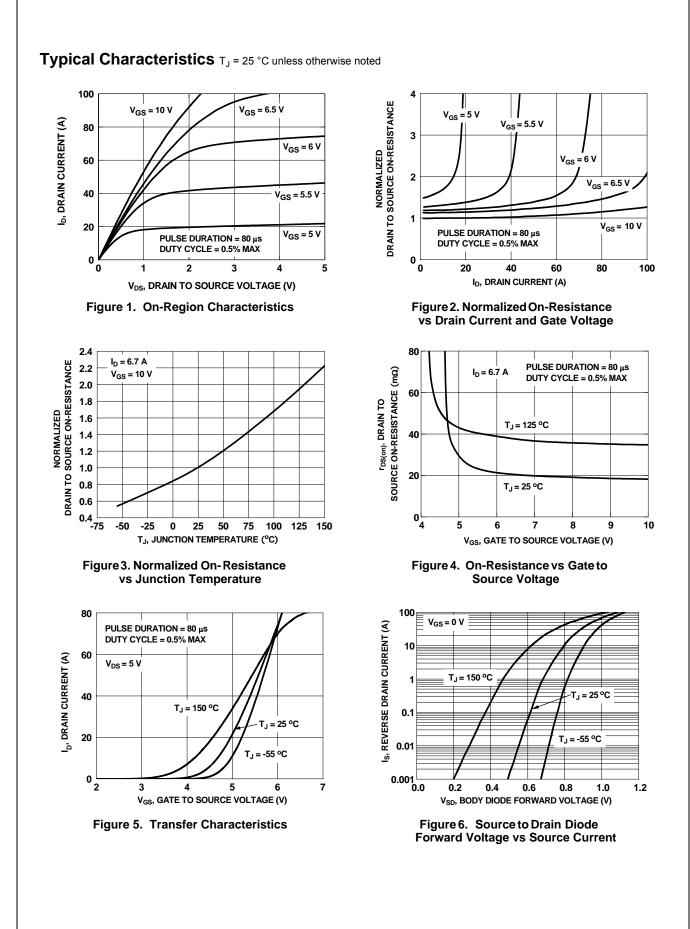
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

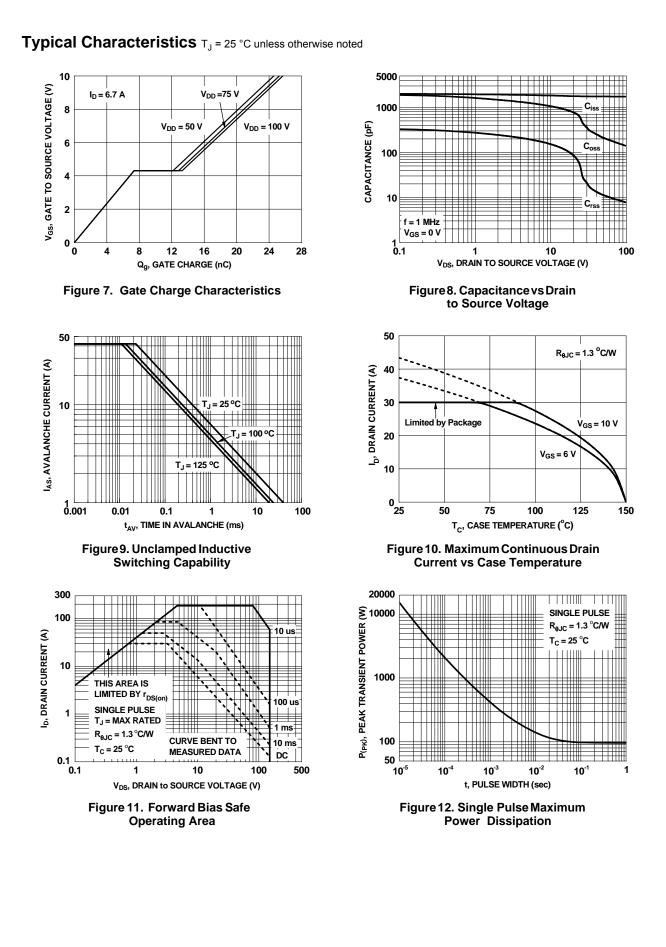
3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 19 A, V_DD = 135 V, V_GS = 10 V.

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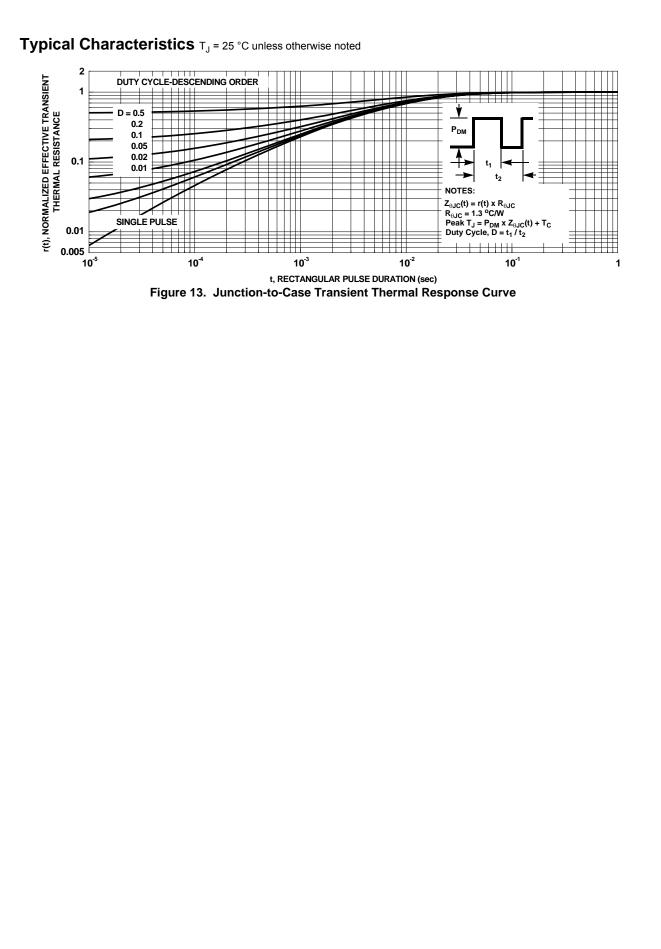
4. Pulse Id limited by junction temperature, td ≤ 100 μ s. Please refer to SOA curve for more details.

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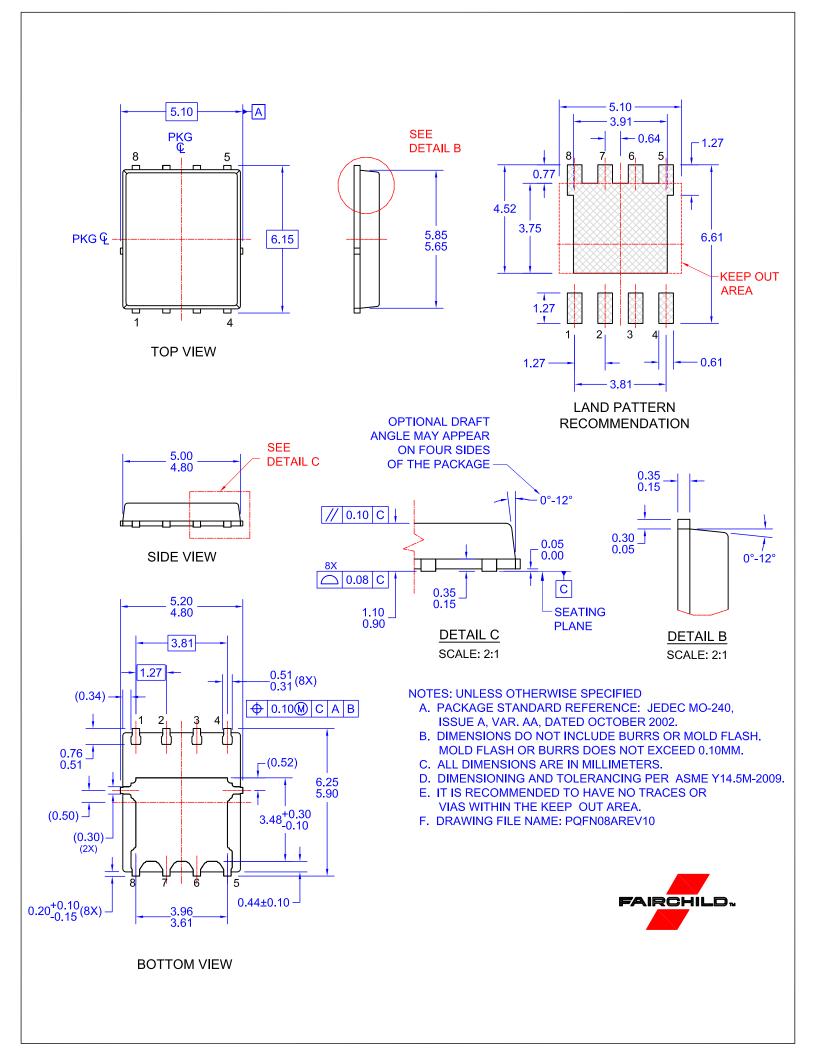




FDMS86250 N-Channel Shielded Gate PowerTrench[®] MOSFET



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